# No Clean Liquid Flux

### **Features:**

- Rosin, Resin and VOC-Free
- Broad Process Window
- Fast Wetting for SN100C® and SAC alloys
- Halide-Free Low Post Process Residues
- Lead-Free and Tin-Lead Compatible

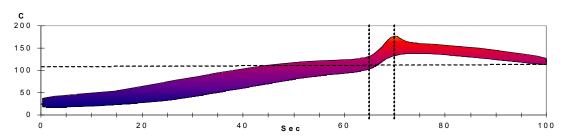
# **Description:**

NC275 is a VOC-free, water-based, no-clean liquid flux formulated to offer a very wide process window for lead-free and tin-lead wave soldering operations. NC275 offers faster wetting for SN100C® and SAC alloys than previously formulated fluxes and is compatible with a broad range of lead-free and tin-lead solder alloys. NC275 offers low post-process residues and has proven to reduce preventative maintenance requirements for spray fluxing applications. In addition, NC275 offers fast solvent evaporation for a VOC-free flux. NC275 is designed to be a no-clean, non-visible residue flux, which can be cleaned if critical to the product application.

#### **Application:**

- NC275 is ready to use directly from the container for spray systems.
- When spray fluxing, it is imperative that proper flux coverage and uniformity be achieved and maintained. A dry flux coating of 500 to 1500 micrograms per square inch is necessary.
- When complete nitrogen sealed wave solder equipment is used, it is generally necessary to apply slightly more flux than normal as a result of excess drying due to the extended length of the equipment.

### **Thermal Profile:**



| RATE of RISE    | PROGRESS THROUGH          | PCB TOP SIDE TEMP              | COOLDOWN |
|-----------------|---------------------------|--------------------------------|----------|
| 2-3°C / SEC MAX | 66°C - 77°C (150 - 170°F) | 90°C - 125°C ( 194°F - 257°F ) | ≤ 4°C    |
|                 | ≤ 40 SECONDS              | JUST BEFORE WAVE               |          |

# Cleaning:

NC275 can be cleaned, if necessary, with saponified water or an appropriate solvent cleaner. Deionized water is recommended for the final rinse. A temperature of  $38^{\circ}\text{C}$  -  $65^{\circ}\text{C}$  ( $100^{\circ}$  -  $150^{\circ}\text{F}$ ) is sufficient for removing any residues. An in-line or other pressurized spray cleaning system is suggested, but is not required.

#### **Handling:**

- NC275 has an unopened shelf life of 6 months when stored at room temperature. Do not freeze this product.
- Do not store near fire or flame. Keep away from sunlight as it may degrade product.
- NC275 is shipped ready-to-use, no mixing necessary.
- Do not mix used and unused chemical in the same container. Reseal any opened containers.

### **Safety:**

- Use with adequate ventilation and proper personal protective equipment.
- Refer to the accompanying Material Safety Data Sheet for any specific emergency information.
- Do not dispose of any hazardous materials in non-approved containers.

# **Physical Properties:**

| Parameter   | Value                            |
|-------------|----------------------------------|
| J-STD-004   | ORM0                             |
| Visual      | Clear, Colorless to light yellow |
| Odor        | Aromatic (Slightly)              |
| Acid Number | 35.4 – 35.7 mg KOH per gram flux |

| Parameter               | Value                     |
|-------------------------|---------------------------|
| Solids Content          | 4.45 – 4.47%              |
| Specific Gravity        | 1.009 - 1.018 (water = 1) |
| Flash Point             | None                      |
| pH (1% solution /water) | Acidic                    |

# **Corrosion Testing:**

| Parameter                            | Requirements      | Results |
|--------------------------------------|-------------------|---------|
| Copper Mirror (24 hrs @ 25°C, 50%RH) | IPC-TM-650-2.3.32 | Medium  |
| Halide Test (Silver Chromate)        | IPC-TM-650-2.2.33 | Pass    |

#### **Surface Insulation Resistance:**

| Reference                                       | Property                      | Pass-Fail Criteria              | Results                                    |
|---|-------------------------------|---------------------------------|--|
| IPC-TM-650<br>method 2.6.3.3<br>85°C / 85% R.H. | Control coupons               | >1E+9 Ω at 96 and 168 hrs       | $3.15E+9 \Omega$ and $3.02E+9 \Omega$ Pass |
|   | Sample coupons – pattern up   | >1E+8 Ω at 96 and 168 hrs       | $3.20E+9 \Omega$ and $3.07E+9 \Omega$ Pass |
|   | Sample coupons – pattern down | >1E+8 Ω at 96 and 168 hrs       | $4.33E+8 \Omega$ and $5.76E+8 \Omega$ Pass |
|   | Post-test visual inspection   | No dendrite growth or corrosion | Pass                                       |

# **Electromigration:**

| Test                      | Conditions                      | Specification | Results                                    |
|---------------------------|---------------------------------|---------------|--|
| Electromigration Bellcore | 65°C/85% R.H. 500 hrs – Control | Rf/Ri > 0.1   | $7.67E+10 \Omega / 5.53E+10 \Omega - Pass$ |
| GR-78 Flux Requirements   | 65°C/85% R.H. 500 hrs – Sample  | Rf/Ri > 0.1   | $1.18E+11 \Omega / 7.90E+09 \Omega - Pass$ |

### Manufacturing and Distribution Worldwide

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